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Approved by:

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Issued by:

SPECIFICATION

PRODUCT: SAW FILTER

MODEL: HDBF75A1M



SHOULDER ELECTRONICS LIMITED

1.SCOPE

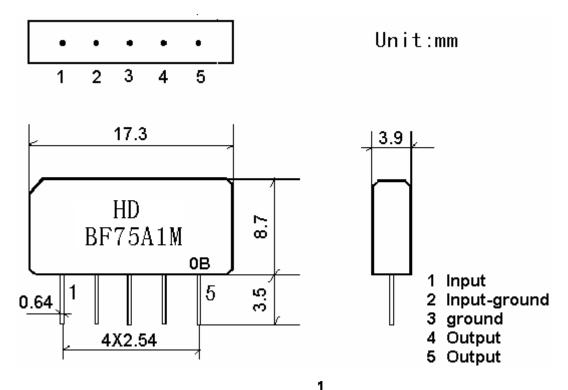
SHOULDER'S SAW filter series have broad line up products meeting all broadcast standard including NTSC,PAL and SECAM systems. These filters are composed of two interdigital transducers on a single-crystal. piezoelectrical chip. they are used in electronic equipments such as TV and so on.

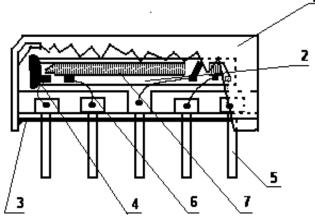
2.Construction

2.1 Dimension and materials

Manufacturer's name: SHOULD ELECTRONICS LTD

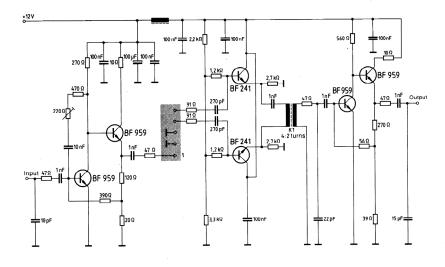
Type: BF75A1M





Components	Materials
1.Outer casing	PPS
2.Substrate	Lithium niobate
3.Base	Epoxy resin
4.Absorber	Epoxy resin
5.Lead	Cu alloy+Au plate
6.Bonding wire	AlSi alloy
7.Electrode	Al

2.2. Circuit construction, measurement circuit



Test circuit for SIP-5 filter Input impedance of the symmetrical post-amplifier: 2 k Ω in parallel with 3 pF

3. Characteristics

Items	Conditions	Specifications
Standard atmospheric conditions	Unless otherwise specified, the standard rang of atmospheric conditions for making measurements and tests is as follows; Ambient temperature : 15°C to 35°C Relative humidity : 25% to 85% Air pressure : 86kPa to 106kPa	
Operating temperature rang	Operating temperature rang is the rang of ambient temperatures in which the filter can be operated continuously. $-10^{\circ}\text{C} \sim +60^{\circ}\text{C}$	There shall be no damage.
Storage temperature rang	Storage temperature rang is the rang of ambient temperatures at which the filter can be stored without damage. Conditions are as specified elsewhere in these specifications. $-40^{\circ}\text{C} \sim +70^{\circ}\text{C}$	
Reference temperature	+25℃	

3.1 Maximum Rating

DC voltage	VDC	12	V	Between any terminals
AC voltage	Vpp	10	V	Between any terminals

3.2 Electrical Characteristics

Source impedance $Zs=50 \Omega$

Load impedance $Z_L=2k \Omega //3pF$ $T_A=25 ^{\circ}C$

Item		Freq	min	typ	max	
Center frequency		Fo	75.13	75.28	75.43	MHz
	Insertion attenuation Reference level		16.2	17.7	19.2	dB
		B6dB	-	1.0	1	MHz
Pass band	dwidth	B20dB	-	1.7	1	MHz
		B30dB	-	2.0	1	
		73.78MHz	35.0	39.0	-	dB
Relative att	Relative attenuation		34.0	45.0	-	dB
			34.0	43.0	1	dB
Lower Sidelobe	65.28~74.08MHz		30.0	38.0	-	dB
Upper Sidelobe	76.48~85.28MHz		32.0	40.0	-	dB
Group	delay rippl	le (p-p)				
Aperture 50 kHz		-	60	-	ns	
74.93~75.63 MHz						
Impedance at 75.28MHz						
Input:	Zin =Rin //Cin		-	0.3//21.9	-	$K\Omega //pF$
Output:	Zout=Rout//Cout			0.2//16.9		
Temperature coefficient				-18		ppm/k

3.3 Environmental Performance Characteristics

Item	Condition	Specifications
High temperature Low temperature	The specimen shall be store at a temperature of $80\pm2^{\circ}\text{C}$ for $96\pm4\text{h}$. Then it shall be subjected to standard atmospheric conditions for 1h, after which measurement shall be made within 1h. The specimen shall be store at a temperature of $-20\pm3^{\circ}\text{C}$ for $96\pm4\text{h}$. Then it shall be subjected to standard atmospheric conditions for 1h, after which measurement shall be made within 1h.	Mechanical characteristics and specifications in electrical
Humidity	The specimen shall be store at a temperature of $40\pm2^{\circ}$ C with relative humidity of 90% to 96% for 96±4h. Then it shall be subjected to standard atmospheric conditions for 1h, after which measurement shall be made within 1h.	characteristics shall be satisfied. There shall be no excessive change in appearance.
Thermal shock	The specimen shall be subjected to 8 continuous cycles each as shown below. Then it shall be subjected to standard atmospheric conditions for 1h, after which measurement shall be made within 1h.	

	TT		<u> </u>	
	Temperature	Duration		
	1 +25 °C=>-40 °C	0.5h		
	2 -40 ℃	4h		
	3 -40 °C=>+85 °C	2h		
	4 +85 °C	4h		
	5 +85 °C=>+25 °C	0.5h		
	6 +25 °C	1h		
Resistance to	Reflow soldering method			
Soldering	Peak: 255 \pm 5 °C, 220 \pm 5	°C, 40s		
heat	At electrode temperature of	the specimen.		
	Temperature pi	ofile of reflow soldering		
		Idering		
	250	-1		
	Pre-heating Pre-heating	s Slow cooling (Store at		
	Pre-heating	room temperature)		
	E 150	1		
	8 100 — /	`\		
	" /	***************************************		
	50 —	\ \ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\		
	-	• •		
	1 to 2 min. 10			
	The specimen shall be pass	<u> </u>		
	furnace with the condition	snown in the above		
	-	profile for 1 time.		
	The specimen shall be stored at standard atmospheric conditions for 1h, after which the			
	measurement shall be made. Test board shall be			
		1.6 mm thick. Base material shall be glass fabric		
	base epoxy resin.	<i>5</i>		
Solder ability	Immerse the pins melt so	lder at 260°C+5/-0°C	More then 95% of	
	for 5 sec.	•		
			pins should be	
			covered with solder	

3.4 Mechanical Test

Items	Conditions	Specifications
Vibration	600-3300rpm amplitude 1.5mm	
	3 directions 2 H each	
Drop	On maple plate from 1 m high 3 times	
		There shall be no
Lead pull	Pull with 1 kg force for 30 seconds	damage.
Lead bend	90° bending with 500g weigh 2 times	-

3.5 Voltage Discharge Test

Item	Condition	Specifications
Surge	Between any two electrode	
	T _{100V} T _{1000p} F 4Mohm	There shall be no damage

3.6 Frequency response

